



Product Change Notification

112514 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112514 - 01
Change Title: Intel® Xeon Phi™ Coprocessors 3120A, 3120P, 5110P, 7120P and 71S1P
PCN 112514-01, Transport Media, Product Material
Reduce Shipping Box Size and Replace Screws
Reason for Revision: Correct Date Typo
Date of Publication: August 30, 2013

Key Characteristics of the Change:

Transport Media
Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Sep 12, 2013
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Description of Change to the Customer:

Reason for Revision: Correct Date Typo

Intel has implemented the following changes on Intel® Xeon Phi™ Coprocessors 3120A, 3120P, 5110P, 7120P and 71S1P:

1. Reduce shipping box size; please refer to table below for new box dimensions.

Pre Conversion	Post Conversion
(L)15.433" x (W)9.843" x (H)3.937"	(L)12.76" x (W)8.90" x (H)2.87"
(L) 392mm x (W) 250mm x (H) 100mm	(L) 324mm x (W) 226mm x (H) 73mm

2. Replacing 4mm screws with 6mm in the Bracket Assembly. Please note there is no Form, Fit or Function change and this is for reference only.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourage customers to understand the changes and determine impact to their applications.

Customers should expect to receive mixed inventory until current inventory levels have been depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	TA #s
SC5110P	924044	G65758-254
SC71S1P	925618	G78939-253
SC7120P	927499	G65757-350
SC3120A	927500	G65759-350
SC3120P	927501	G82474-350

PCN Revision History:

Date of Revision:

August 28, 2013

August 30, 2013

Revision Number:

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01

Reason:

Originally Published PCN

Correct Date Typo